

DHG30IM600PC

preliminary

 $V_{RRM} = 600 V$

 $I_{FAV} = 30 A$

 $t_{rr} = 35 \, \text{ns}$

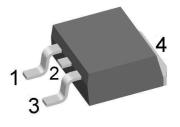
High Performance Fast Recovery Diode Low Loss and Soft Recovery Single Diode

Sonic Fast Recovery Diode

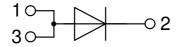
Part number

DHG30IM600PC

Marking on Product: DHG30IM600PC



Backside: cathode



Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low Irm-values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low Irm reduces:
 - Power dissipation within the diode
 - Turn-on loss in the commutating switch

Applications:

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

Package: TO-263 (D2Pak)

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

Disclaimer Notice

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| Fast Diode | | | | Ratings | | | |
|-------------------|-------------------------------------|---|--------------------------------|---------|------|------|-------------|
| Symbol | Definition | Conditions | | min. | typ. | max. | Unit |
| V _{RSM} | max. non-repetitive reverse blockii | ng voltage | $T_{VJ} = 25^{\circ}C$ | | | 600 | V |
| V_{RRM} | max. repetitive reverse blocking vo | oltage | $T_{VJ} = 25^{\circ}C$ | | | 600 | V |
| I _R | reverse current, drain current | $V_R = 600 \text{ V}$ | $T_{VJ} = 25^{\circ}C$ | | | 50 | μΑ |
| | | $V_R = 600 V$ | $T_{VJ} = 125^{\circ}C$ | | | 4 | mΑ |
| V _F | forward voltage drop | I _F = 30 A | $T_{VJ} = 25^{\circ}C$ | | | 2.26 | V |
| | | $I_F = 60 \text{ A}$ | | | | 3.11 | ٧ |
| | | I _F = 30 A | T _{vJ} = 125°C | | | 2.22 | ٧ |
| | | $I_F = 60 \text{ A}$ | | | | 3.20 | ٧ |
| I _{FAV} | average forward current | $T_{C} = 95^{\circ}C$ | T _{VJ} = 150°C | | | 30 | Α |
| | | rectangular d = 0.5 | | | | | i ! ! |
| V _{F0} | threshold voltage | | T _{VJ} = 150°C | | | 1.17 | V |
| r _F | slope resistance | ss calculation only | | | | 32 | mΩ |
| R _{thJC} | thermal resistance junction to case | 9 | | | | 0.6 | K/W |
| R _{thCH} | thermal resistance case to heatsin | k | | | 0.25 | | K/W |
| P _{tot} | total power dissipation | | $T_C = 25^{\circ}C$ | | | 210 | W |
| I _{FSM} | max. forward surge current | $t = 10 \text{ ms}$; (50 Hz), sine; $V_R = 0 \text{ V}$ | $T_{VJ} = 45^{\circ}C$ | | | 200 | Α |
| CJ | junction capacitance | $V_R = 400 \text{V}$ f = 1 MHz | $T_{VJ} = 25^{\circ}C$ | | 16 | | pF |
| I _{RM} | max. reverse recovery current | | T _{VJ} = 25 °C | | 12 | | Α |
| | , | $I_F = 35 \text{ A}; V_R = 400 \text{ V}$ | $T_{VJ} = {}^{\circ}C$ | | tbd | | Α |
| t _{rr} | reverse recovery time | $I_F = 35 \text{ A}; V_R = 400 \text{ V}$ $-\text{di}_F / \text{dt} = 600 \text{ A} / \mu \text{s}$ | $T_{VJ} = 25 ^{\circ}\text{C}$ | | 35 | | ns |
| | | l | $T_{VJ} = {}^{\circ}C$ | | tbd | | ns |



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| Package | TO-263 (D2Pak) | | F | Ratings | S | |
|---|------------------------------|--|------|---------|------|------|
| Symbol | Definition | Conditions | min. | typ. | max. | Unit |
| I _{RMS} | RMS current | per terminal 1) | | | 35 | Α |
| T _{VJ} | virtual junction temperature | | -55 | | 150 | °C |
| T _{op} | operation temperature | | -55 | | 125 | °C |
| T _{stg} | storage temperature | | -55 | | 150 | °C |
| Weight | Product Marking | Part description | | 2 | | g |
| F _c | mounting force with clip | D = Diode | 20 | | 60 | N |
| 1) l; w Part No Logo — Assembly Li Date Co | de + 000000 | of the chip (2). In case of (1) and a pg scheme fast s | | | | |
| Assembly Co | de | | | | | |

| Ordering | Ordering Number | Marking on Product | Delivery Mode | Quantity | Code No. |
|-------------|------------------|--------------------|---------------|----------|----------|
| Standard | DHG30IM600PC-TRL | DHG30IM600PC | Tape & Reel | 800 | 503501 |
| Alternative | DHG30IM600PC-TUB | DHG30IM600PC | Tube | 50 | 525078 |

| Similar Part | Package | Voltage class |
|--------------|--------------|---------------|
| DHG30I600PA | TO-220AC (2) | 600 |
| DHG30I600HA | TO-247AD (2) | 600 |

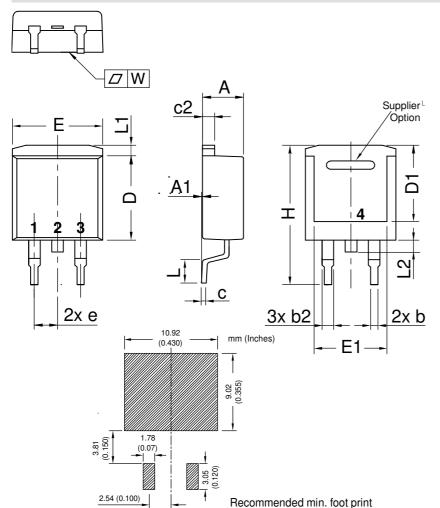
| Equivalent Circuits for Simulation | | | * on die level | $T_{VJ} = 150 ^{\circ}\text{C}$ |
|---|--------------------|---------------|----------------|---------------------------------|
| $I \rightarrow V_0$ | R_0 | Fast Diode | | |
| V _{0 max} | threshold voltage | 1.17 | | V |
| $R_{0 max}$ | slope resistance * | 29 | | $m\Omega$ |





preliminary

Outlines TO-263 (D2Pak)



| Dim. | Millimeter | | Inches | | |
|--------|--------------|-------|----------------|-------|--|
| DIIII. | min | max | min | max | |
| Α | 4.06 | 4.83 | 0.160 | 0.190 | |
| A1 | typ. | 0.10 | typ. C | 0.004 | |
| A2 | 2. | 41 | 0.095 | | |
| b | 0.51 | 0.99 | 0.020 | 0.039 | |
| b2 | 1.14 | 1.40 | 0.045 | 0.055 | |
| С | 0.40 | 0.74 | 0.016 | 0.029 | |
| c2 | 1.14 | 1.40 | 0.045 | 0.055 | |
| D | 8.38 | 9.40 | 0.330 | 0.370 | |
| D1 | 8.00 | 8.89 | 0.315 | 0.350 | |
| D2 | 2.5 | | 0.098 | | |
| Е | 9.65 | 10.41 | 0.380 | 0.410 | |
| E1 | 6.22 | 8.50 | 0.245 | 0.335 | |
| е | 2,54 BSC | | 0,100 BSC | | |
| e1 | 4.28 | | 0.169 | | |
| Н | 14.61 | 15.88 | 0.575 | 0.625 | |
| L | 1.78 | 2.79 | 0.070 | 0.110 | |
| L1 | 1.02 | 1.68 | 0.040 | 0.066 | |
| W | typ. 0.02 | 0.040 | typ. 0.0008 | 0.002 | |

All dimensions conform with and/or within JEDEC standard.

